SGM803B/SGM809B/SGM810B Low Power Microprocessor Supervisory Circuit in 3-Pin SOT-23

GENERAL DESCRIPTION

SGMICRO

The SGM803B/SGM809B/SGM810B supervisory circuits monitor the power supply voltage in microprocessor and digital systems. They provide a reset output during power-up, power-down and brownout conditions. On power-up, an internal timer holds reset asserted for 330ms. This holds the microprocessor in a reset state until conditions have stabilized. The nRESET output remains operational with V_{CC} as low as 1V. The SGM803B/SGM809B provides an active low reset signal (nRESET) while the SGM810B provides an active high signal (RESET) output. The SGM803B/SGM810B has push-pull outputs, whereas the SGM803B has an open-drain output, which requires an external pull-up resistor.

Five reset threshold voltage options are available suitable for monitoring 3V, 3.3V and 5V supply voltages.

The reset comparator features built-in glitch immunity, making it immune to fast transients on $V_{\text{CC}}.$

The low supply current of typically 240nA makes the SGM803B/SGM809B/SGM810B ideal for use in portable, battery operated equipment. All are specified over the extended -40 $^{\circ}$ C to +125 $^{\circ}$ C temperature range.

FEATURES

- Precision Voltage Monitor: 3V, 3.3V, 5V Options
- Superior Upgrade for MAX803/MAX809/MAX810 and ADM803/ADM809/ADM810
- Fully Specified over Temperature
- VCC Transient Immunity
- Low Power Consumption: 240nA (TYP)
- Reset Assertion Down to 1V V_{cc}
- 330ms Power-On Reset (TYP)
 Open-Drain nRESET Output (SGM803B)
 Push-Pull nRESET Output (SGM809B)
 Push-Pull RESET Output (SGM810B)
- -40°C to +125°C Operating Temperature Range
- Small Packaging SGM803B Available in SOT-23-3 and SOT-23 SGM809B Available in SOT-23-3 and SOT-23 SGM810B Available in SOT-23-3 and SOT-23

APPLICATIONS

Microprocessor Systems Controllers Intelligent Instruments Automotive Systems Safety Systems Portable Instruments

TYPICAL APPLICATION





PACKAGE/ORDERING INFORMATION

MODEL	RESET THRESHOLD (V)	PACKAGE DESCRIPTION	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
	4.38	SOT-23-3	SGM803B-MXN3G/TR	M18XX	Tape and Reel, 3000
	4.38	SOT-23	SGM803B-MXN3LG/TR	M19XX	Tape and Reel, 3000
	4.00	SOT-23-3	SGM803B-JXN3G/TR	M1AXX	Tape and Reel, 3000
	4.00	SOT-23	SGM803B-JXN3LG/TR	M1BXX	Tape and Reel, 3000
SGM803B	3.08	SOT-23-3	SGM803B-TXN3G/TR	M1CXX	Tape and Reel, 3000
SGIVIOUSD	3.08	SOT-23	SGM803B-TXN3LG/TR	M1DXX	Tape and Reel, 3000
	2.93	SOT-23-3	SGM803B-SXN3G/TR	M1EXX	Tape and Reel, 3000
	2.93	SOT-23	SGM803B-SXN3LG/TR	GZ5XX	Tape and Reel, 3000
	2.63	SOT-23-3	SGM803B-RXN3G/TR	M1FXX	Tape and Reel, 3000
	2.63	SOT-23	SGM803B-RXN3LG/TR	M20XX	Tape and Reel, 3000
	4.38	SOT-23-3	SGM809B-MXN3G/TR	M21XX	Tape and Reel, 3000
	4.38	SOT-23	SGM809B-MXN3LG/TR	M22XX	Tape and Reel, 3000
	4.00	SOT-23-3	SGM809B-JXN3G/TR	M23XX	Tape and Reel, 3000
	4.00	SOT-23	SGM809B-JXN3LG/TR	M24XX	Tape and Reel, 3000
SGM809B	3.08	SOT-23-3	SGM809B-TXN3G/TR	M25XX	Tape and Reel, 3000
SCINIOUAD	3.08	SOT-23	SGM809B-TXN3LG/TR	GZ4XX	Tape and Reel, 3000
	2.93	SOT-23-3	SGM809B-SXN3G/TR	GZ0XX	Tape and Reel, 3000
	2.93	SOT-23	SGM809B-SXN3LG/TR	GYEXX	Tape and Reel, 3000
	2.63	SOT-23-3	SGM809B-RXN3G/TR	GZ2XX	Tape and Reel, 3000
	2.63	SOT-23	SGM809B-RXN3LG/TR	GZ1XX	Tape and Reel, 3000
	4.38	SOT-23-3	SGM810B-MXN3G/TR	M26XX	Tape and Reel, 3000
	4.38	SOT-23	SGM810B-MXN3LG/TR	M27XX	Tape and Reel, 3000
	4.00	SOT-23-3	SGM810B-JXN3G/TR	M28XX	Tape and Reel, 3000
	4.00	SOT-23	SGM810B-JXN3LG/TR	M29XX	Tape and Reel, 3000
	3.08	SOT-23-3	SGM810B-TXN3G/TR	M2AXX	Tape and Reel, 3000
SGM810B	3.08	SOT-23	SGM810B-TXN3LG/TR	M2BXX	Tape and Reel, 3000
l [2.93	SOT-23-3	SGM810B-SXN3G/TR	M2CXX	Tape and Reel, 3000
ļ Ē	2.93	SOT-23	SGM810B-SXN3LG/TR	GYFXX	Tape and Reel, 3000
ļ Ē	2.63	SOT-23-3	SGM810B-RXN3G/TR	M2DXX	Tape and Reel, 3000
	2.63	SOT-23	SGM810B-RXN3LG/TR	GZ3XX	Tape and Reel, 3000

NOTE: XX = Date Code.

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

MARKING INFORMATION



Date code - Month ("A" = Jan. "B" = Feb. ··· "L" = Dec.)
Date code - Year ("A" = 2010, "B" = 2011 ···)
Chip I.D.

For example: M18FA (2015, January)



SGM803B/SGM809B/SGM810B

ABSOLUTE MAXIMUM RATINGS

V _{CC}	0.3V to 6V
RESET, nRESET	0.3V to V _{CC} + 0.3V
Input Current, V _{CC}	20mA
Output Current, RESET, nRESET	20mA
Rate of Rise, V _{CC}	100V/µs
Power Dissipation, P _D @ T _A = +25°C	
SOT-23-3	0.4W
Package Thermal Resistance	
SOT-23-3, θ _{JA}	250°C/W
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range-40°C to +125°C

Low Power Microprocessor Supervisory Circuit in 3-Pin SOT-23

OVERSTRESS CAUTION

Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

ESD SENSITIVITY CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time.



PIN CONFIGURATIONS



PIN DESCRIPTION

NAME	I		ł	FUNCTION
NAME	SGM803B	SGM809B	SGM810B	FUNCTION
GND	1	1	1	Ground.
nRESET	2	2	_	Active Low Reset (SGM803B/SGM809B). nRESET remains low while V_{CC} is below the reset threshold, and remains low for 330ms (TYP) after V_{CC} rises above the reset threshold.
RESET	_	_	2	Active High Reset (SGM810B). RESET remains high while V_{CC} is below the reset threshold, and remains high for 330ms (TYP) after V_{CC} rises above the reset threshold.
V _{CC}	3	3	3	Power Supply. Power supply voltage that is monitored.



ELECTRICAL CHARACTERISTICS

(V_{CC} = 5V for M/J Models, 3.3V for T/S Models, 3V for R Models, unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
SUPPLY						
Voltage	T _A = +25°C	1.0		5.5	V	
Quinter	V _{CC} < 5.5V, SGM8_M/J, T _A = +25°C		320		nA	
Current	V _{CC} < 3.6V, SGM8_R/S/T, T _A = +25°C		240		nA	
RESET VOLTAGE THRESHOLD					•	
SGM8_M	T _A = +25°C		4.38		V	
SGM8_J	T _A = +25°C		4.00		V	
SGM8_T	T _A = +25°C		3.08		V	
SGM8_S	$T_A = +25^{\circ}C$		2.93		V	
SGM8_R	T _A = +25°C		2.63		V	
Reset Threshold Temperature Coefficient			50		ppm/°C	
V _{CC} to RESET/nRESET Delay	$V_{CC} = V_{TH}$ to (V_{TH} - 200mV)		50		μs	
Reset Active Timeout Period	T _A = +25°C		330		ms	
RESET/nRESET OUTPUT VOLTAGE	-	•				
Low (SGM803B-R/S/T) Low (SGM809B-R/S/T)	$V_{CC} = V_{TH(MIN)}$, $I_{SINK} = 1.2mA$		50		mV	
Low (SGM803B-M/J) Low (SGM809B-M/J)	$V_{CC} = V_{TH(MIN)}$, $I_{SINK} = 3.2mA$		100		mV	
Low (SGM803B-R/S/T/M/J) Low (SGM809B-R/S/T/M/J)	V _{CC} > 1.0V, I _{SINK} = 50µA		50		mV	
High (SGM809B-R/S/T)	$V_{CC} > V_{TH(MAX)}$, $I_{SOURCE} = 500 \mu A$		$0.9 \times V_{CC}$		V	
High (SGM809B-M/J)	$V_{CC} > V_{TH(MAX)}, I_{SOURCE} = 800 \mu A$		$0.9 \times V_{CC}$		V	
Low (SGM810B-R/S/T)	$V_{CC} = V_{TH(MAX)}, I_{SINK} = 1.2mA$		50		mV	
Low (SGM810B-M/J)	$V_{CC} = V_{TH(MAX)}$, $I_{SINK} = 3.2mA$		100		mV	
High (SGM810B-R/S/T/M/J)	$1.8V < V_{CC} < V_{TH(MIN)}, I_{SOURCE} = 150 \mu A$		$0.9 \times V_{CC}$		V	
nRESET Open-Drain Output Leakage Current (SGM803B)	V_{CC} > V_{TH} , reset de-asserted		40		nA	



APPLICATION INFORMATION

Benefits of an Accurate Reset Threshold

In other microprocessor supervisory circuits, tolerances in supply voltages lead to an overall increase in reset tolerance levels due to the deterioration of the microprocessor reset circuit's power supply. The possibility of a malfunction during a power failure is greatly reduced because the SGM803B/SGM809B/ SGM810B series can operate effectively even when there are large degradations of the supply voltages. Another advantage of the SGM803B/SGM809B/ SGM810B series is its very accurate internal voltage reference circuit. These benefits combine to produce an exceptionally reliable voltage monitor circuit.

Interfacing to Microprocessors with Multiple Interrupts

In a number of cases, it is necessary to interface many interrupts from different devices (for example, thermal, altitude, and velocity sensors). The SGM803B/SGM809B/ SGM810B can easily be integrated into existing interrupt-handling circuits, as shown in Figure 1, or can be used as a standalone device.





Interfacing to Other Devices' Output

The SGM803B/SGM809B/SGM810B series is designed to integrate with as many devices as possible and, therefore, has a standard output dependent on V_{CC} . This enables the parts to be used in both 3V and 5V, or any nominal voltage within the minimum and maximum specifications for V_{CC} . This design simplifies interfacing this device to other devices.

Ensuring a Valid Reset Output Down to V_{CC} = 0V

When V_{CC} falls below 1.0V, the SGM803B/SGM809B nRESET no longer sinks current. A high impedance CMOS logic input connected to nRESET may, therefore, drift to undetermined logic levels. To eliminate this problem, a 100k Ω resistor should be connected from nRESET to ground.



Figure 2. Ensuring a Valid Reset Output Down to V_{cc} = 0V

Preventing the High Voltage Spike and Low Power Design

To prevent the high voltage spike damage or input V_{CC} current limitation low power design, It is always to connect a resistor R1(0 Ω to 1k Ω) in series to V_{CC}, for such application, one capacitance C1(0.1 μ F to 4.7 μ F) should be connected between V_{CC} Pin and GND. the schematic is shown in Figure 3. The input resistor will affect output driving capability.







SGM803B/SGM809B/SGM810B

DETAILED DESCRIPTIONS

Reset Timing

The reset signal is asserted LOW for the SGM809B and HIGH for the SGM810B when the power supply voltage falls below the threshold trip voltage and remains asserted for 330ms (TYP) after the power supply voltage has risen above the threshold.



Figure 4. Reset Timing Diagram



PACKAGE OUTLINE DIMENSIONS

SOT-23





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol		nsions meters	-	nsions ches
	MIN	MAX	MIN	MAX
А	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.300 0.500		0.020
С	0.080 0.150		0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.200 1.400		0.055
E1	2.250	2.250 2.550		0.100
e	0.950	0.950 BSC		BSC
e1	1.900 BSC		0.075 BSC	
L	0.550 REF		0.022	2 REF
L1	0.300	0.500	0.012	0.020
θ	0° 8°		0°	8°



PACKAGE OUTLINE DIMENSIONS

SOT-23-3





RECOMMENDED LAND PATTERN (Unit: mm)





Symbol		nsions meters	Dimensions In Inches		
,	MIN	MAX	MIN	MAX	
А	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
с	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
e	0.950	BSC	0.037	BSC	
e1	1.900 BSC		0.075	BSC	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	



TAPE AND REEL INFORMATION

REEL DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOT-23-3	7″	9.0	3.20	3.30	1.30	4.0	4.0	2.0	8.0	Q3
SOT-23	7"	9.5	3.15	2.77	1.22	4.0	4.0	2.0	8.0	Q3

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
7" (Option)	368	227	224	8	
7"	442	410	224	18	00002

